

#### **Features**

- This series is UL listed under the Recognized Component Index, file number E142814
- Ideal for printed circuit board mounting
- The plastic material used carries Underwriters Laboratory flammability recognition 94V-0
- Built-in printed circuit board stand-offs
- High case dielectric strength
- High temperature soldering guaranteed 265°C /10 seconds at 5 lbs (2.3kg) tension



**KBP** 

# **Package Marking and Ordering Information**

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Product ID	Pack	Marking	Qty(PCS)			
KBP3005-KBP310	KBP	KBP3xx	500			



## Maxmim Ratings (Ta=25 unless otherwise noted)

Parameter	Symbol	KBP 3005	KBP 301	KBP 302	KBP 304	KBP 306	KBP 308	KBP 310	Unit
Maximum repetitive peak reverse voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS bridge input voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	50	100	200	400	600	800	1000	V
Maximum average forward rectified output current at TA=100°C	IF(AV)	3.0 80						А	
Peak forward surge current single sine-wave superimposed on rated load (JEDEC Method)	IFSM							А	
Rating for fusing (t<8.3ms)	I <sup>2</sup> t	15.0							A <sup>2</sup> sec
Typical thermal resistance per element (1)	ReJA	10						°C/W	
Typical junction capacitance per element (2)	Cj	25.0					pF		
Operating junction and storage temperature range	TJ, TSTG	-55 to + 150						°C	

### **Electrical Characteristics**

Rating at  $25^{\circ}$ C ambient temperature unless otherwise specified. Resistive or Inductive load, 60Hz. For Capacitive load derate by 20 %.

Parameter	Symbol	KBP 3005	KBP 301	KBP 302	KBP 304	KBP 306	KBP 308	KBP 310	Unit
Maximum instantaneous forward voltage drop per leg at 3.0A	VF	1.1							V
Maximum DC reverse current at rated TA =25°C DC blocking voltage per element TA =125°C	IR	5.0 500						μΑ	

Notes: (1)Thermal resistance from Junction to Ambemt on P.C.board mounting.

(2)Measured at 3.0MHz and applied reverse voltage of 4.0 volts.



# Rating and Characteristic Curves (TA=25°C Unless otherwise noted)

Output Rectified Current

2.0

1.5

1.5

Ambient

1.0

50

100

150

Case Temperature, C

Fig. 1 Derating Curve for

Fig. 3 Typical Instantaneous Forward Characteristics

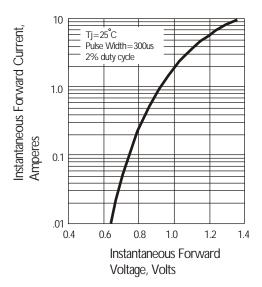


Fig. 2 Maximum Non-repetitive Peak ForwardSurge Current

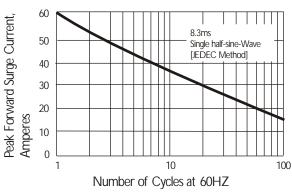


Fig. 4 Typical Reverse Characteristics

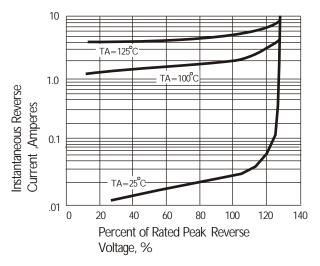
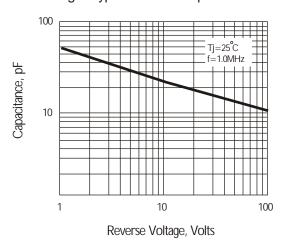


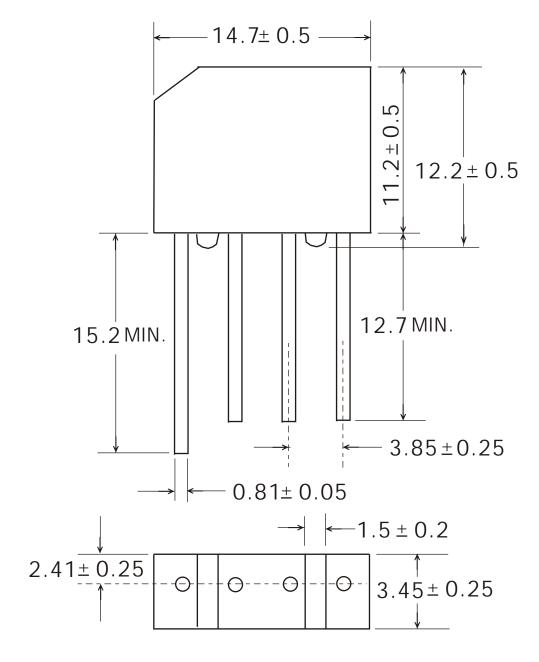
Fig. 5 Typical Junction Capacitance





# **Package Outline Dimensions**

**KBP** 



Dimensions in millimeters(1mm =0.0394")



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